

March 2024 Billings (Express Report)

Japan-based Semiconductor Manufacturing Equipment

Note : All data is based on three month average numbers.

Mark your calendars. [The April Report SEAJ's Web site update](#) is scheduled on **27th May** approximately 3:40P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts **March 2024 Billings of ¥365,680 million**

Tokyo Japan, [April 23rd, 2024](#) JAPAN-based manufacturers of semiconductor equipment posted **¥365,680 million** in billings in [March 2024](#)(three-month average basis) published today by SEAJ.

The billings figure is **15.2% percent up** the final [February 2024](#) level of **¥317,418 million** and **8.5 percent up** the [2023 March](#) billings level of **¥337,042 million**.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Month-Over-Month	Year-Over-Year
October 2023revised	289,198	-3.4%	-16.7%
November 2023revised	300,187	3.8%	-10.5%
December 2023revised	306,412	2.1%	-0.1%
January 2024	314,875	2.8%	5.0%
February 2024(final)	317,418	0.8%	7.8%
March 2024(prelim)	365,680	15.2%	8.5%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

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